

Integrated
Surface
Technologies

Repellix™ Protection from Water Damage Catastrophes



Losing Connectivity Can be a Disaster!

Because of their portability, consumer electronic products are continually at risk of damage by water. Cell phones dropped in pools or toilets, drinks spilled on laptop keyboards, water splashed on BlackBerry's are all common occurances.

Water or liquid damage is among the top two reasons for early electronic failures and customer returns. Moreover, manufacturer's warranty terms strictly exclude water damage as a valid claim. There are even secret tell-tale stickers inside cell phones that turn red if moistened so that manufacturers can refuse these claims.

Water protection for these devices has been an aftermarket after-thought until recently. Clumsy clam shell skins, seals, and other types of water-proof packaging make the devices hard to use, degrade their designed ergonomics, and add significant cost. On the other hand, the "ruggedized" versions of these products are sold at high cost premiums.

Repellix from IST now offers a low-cost solution for protecting these devices from water or other liquid damage without degrading their appeal, nor ease of use.

- Protection from Accidental Drops
- Protection from Splashes or Rain
- Keeps Data Safe During Recovery
- Avoid Replacement Costs
- Operate Near Water with Confidence



Lost Data is Just a Splash Away!

Repellix Protected Cellphone Lasts 30 Minutes Under Water - Without Skins!



Thats right - 30 minutes without skins or gaskets.

Repellix directly coats the electronics inside - it is not a superficial skin or enclosure. It repels water so aggressively that it creates a displacement zone that fills with air as it pushes the water away. It is as if the electronics were still in the dry air, even though the device may be under water.

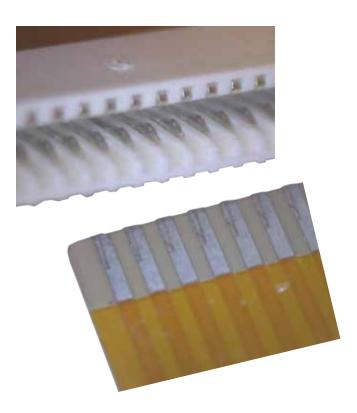
By coating the internal circuits with a super-thin ceramic layer, Repellix enables devices to retain their attractive ergonomics and usability. Flex connectors will even make positive connection through the coating, so no masking is required by the PCB and flex circuit assembler.

What is Repellix?

- **●** 100-2,000 X thinner than spray coatings
- Super-hydrophobic contact angles > 160°
- Electrical contact without masking
- Connectors or probes can penetrate the coating
- Excellent heat dissipation
- Ceramic structure is inert: electrically, chemically, and biologically
- Dry processing without volatile organic compounds (VOCs)

Flex Connector Friendly Coating

Flex Circuits are heavily used in the electronics industry. Since male and female connectors have to connect to their mates, designers cannot protect the connectors with conformal coatings that physically block electrical contact, so the connectors are left exposed to potential water damage. The hard metallic barbs can perforate Repellix and make excellent electrical connection, while remaining protected from water damage elsewhere.



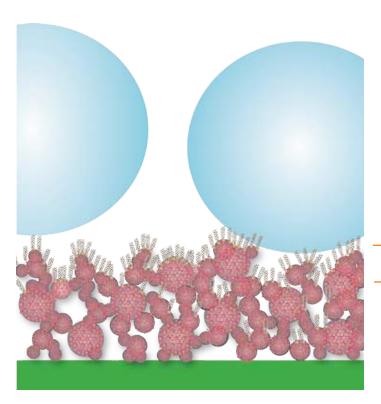
Droplets of a blue sports drink on uncoated silicon (left) form a large puddle. The Repellix-coated silicon (right) displays superhydrophobic contact angles.



Un-Coated Silicon

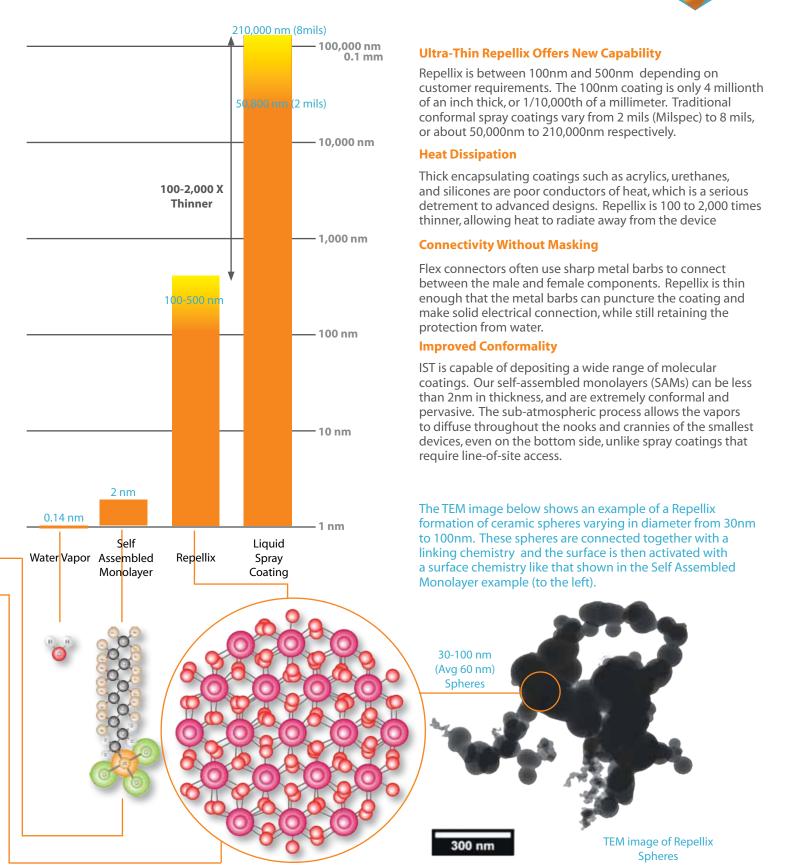
Repellix-Coated Silicon

Water Droplets Roll Off Repellix



Repellix's ceramic structure can be tuned to the desired density, depth, and hardness. The extremely low surface energy within the film itself repels water and other fluids. The film is so thin that it is practically invisible to the naked eye. Repellix's designed porosity allows for excellent heat transfer between PCB components and the environment. Additionally, Repellix allows for good and reliable electrical interface connections.

Advantages of Thin, Super-Molecular Coatings



Technical Specifications

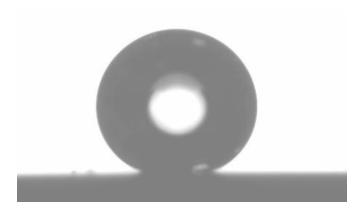
Super-hydrophobic contact angles: > 150°

Contact angle uniformity: +/- 5%

Surface energy: < 3 µJm⁻²

Water Vapor Transmission Rate (WVTR): <0.02gm/ meter²-day (85% RH, Mocon on PEN 10nm film)

Static submersion time: > 6 months



Estimated Density: 2.4-2.5 g/cm³

Stress: <0.4 MPa @33°C

Elastic (Young's) Modulus: 165 GPa Hardness: 12 GPa (Berkowitz Scale) Dielectric Strength: 20 MV/cm

Thickness: 30-500 nm

RMS (Roughness): 60-120 nm

Maximum Temperature: 250°C for 1 hour

Heat Dissipation: Excellent Refractive Index: 1.58

Optical Transmission: <2% absorbtion over spectra

range 400-2100nm (20nm thick film)

Test Results and Literature Available



















